MOSFET - SiC Power, Single N-Channel

1200 V, 20 mΩ, 103 A

NTHL020N120SC1

Features

- Typ. $R_{DS(on)} = 20 \text{ m}\Omega$
- Ultra Low Gate Charge ($Q_{G(tot)} = 203 \text{ nC}$)
- Capacitance (Coss = 260 pF)
- 100% UIL Tested
- These Devices are RoHS Compliant
- Typical Applications
- UPS
- DC/DC Converter
- Boost Inverter

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

D			0	M -1	11
Parame	eter		Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	1200	V
Gate-to-Source Voltage			V _{GS}	-15/+25	V
Recommended Opera- tion Values of Gate-to- Source Voltage	T _C < 175°C		V _{GSop}	-5/+20	V
Continuous Drain Current $R_{\theta JC}$	Steady State	$T_C = 25^{\circ}C$	Ι _D	103	A
Power Dissipation $R_{\theta JC}$			PD	535	W
Continuous Drain Current $R_{\theta JC}$	Steady State	T _C = 100°C	۱ _D	73	A
Power Dissipation $R_{\theta JC}$			PD	267	W
Pulsed Drain Current (Note 2)	$T_A = 25^{\circ}C$		I _{DM}	412	A
Operating Junction and S Range	torage Te	mperature	T _J , T _{stg}	–55 to +175	°C
Source Current (Body Dic	ode)		۱ _S	54	А
Single Pulse Drain-to-So Energy (I _{L(pk)} = 23 A, L =			E _{AS}	264	mJ

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case (Note 1)	$R_{\theta JC}$	0.28	°C/W
Junction-to-Ambient (Note 1)	$R_{\theta JA}$	40	°C/W

 The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

- 2. Repetitive rating, limited by max junction temperature.
- 3. E_{AS} of 264 mJ is based on starting T_J = 25°C; L = 1 mH, I_{AS} = 23 A, V_{DD} = 120 V, V_{GS} = 18 V.

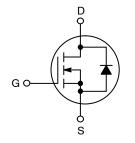


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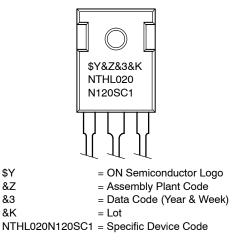
V _{(BR)DSS}	R _{DS(on)} MAX	I _D MAX
1200 V	28 mΩ @ 20 V	103 A







MARKING DIAGRAM



ORDERING INFORMATION

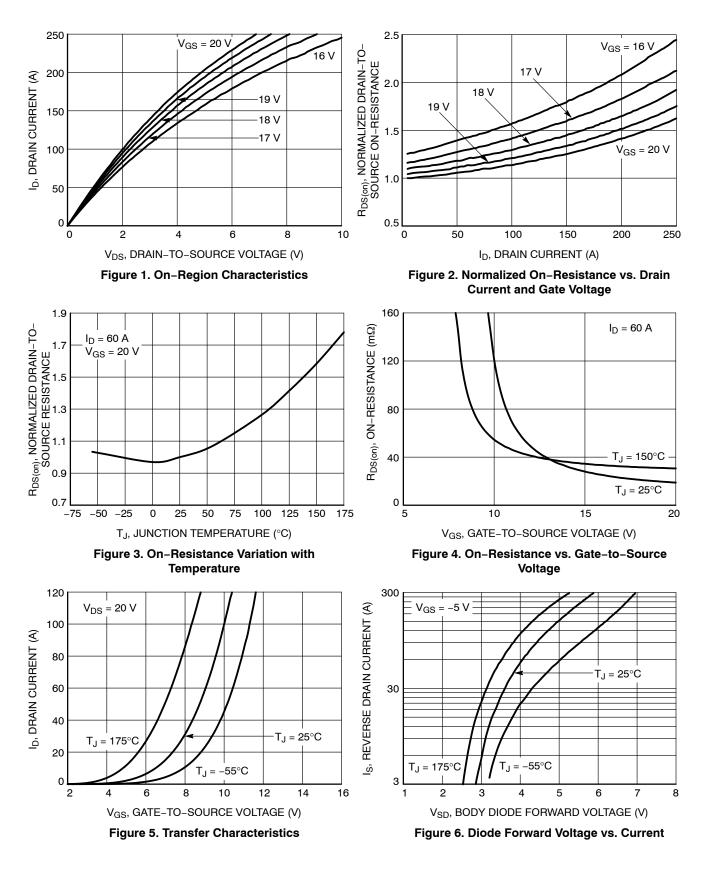
See detailed ordering and shipping information on page 2 of this data sheet.

ELECTRICAL CHARACTERISTICS

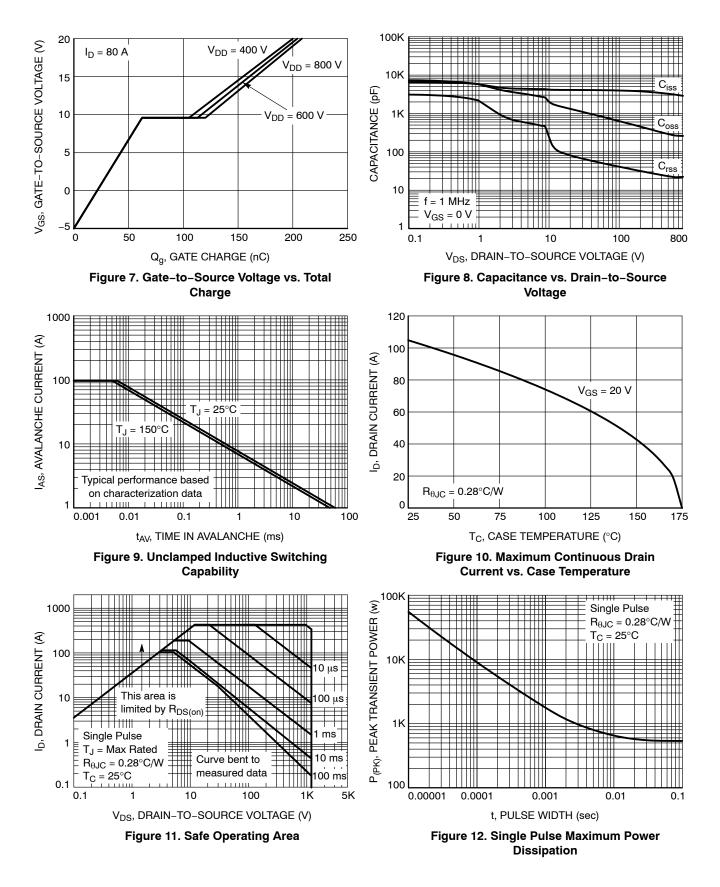
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 1 mA	1200	-	-	V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J	$I_D = 1$ mA, referenced to $25^{\circ}C$	-	900	-	mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V_{GS} = 0 V, V_{DS} = 1200 V, T_J = 25 $^\circ C$	-	-	100	μA
		V_{GS} = 0 V, V_{DS} = 1200 V, T_{J} = 175°C	-	-	250	
Gate-to-Source Leakage Current	I _{GSS}	V_{GS} = +25/-15 V, V_{DS} = 0 V	-	-	±1	μA
ON CHARACTERISTICS						
Gate Threshold Voltage	V _{GS(th)}	$V_{GS} = V_{DS}, I_D = 20 \text{ mA}$	1.8	2.7	4.3	V
Recommended Gate Voltage	V _{GOP}		-5	-	+20	V
Drain-to-Source On Resistance	R _{DS(on)}	V_{GS} = 20 V, I _D = 60 A, T _J = 25 °C	-	20	28	mΩ
		V_{GS} = 20 V, I _D = 60 A, T _J = 175°C	-	35	50	
Forward Transconductance	9 _{FS}	V _{DS} = 10 V, I _D = 60 A	-	28	-	S
CHARGES, CAPACITANCES & GATE	RESISTANCE					
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 800 V	-	2890	-	pF
Output Capacitance	C _{OSS}		-	260	-]
Reverse Transfer Capacitance	C _{RSS}		-	22	-	
Total Gate Charge	Q _{G(tot)}	$V_{GS} = -5/20$ V, $V_{DS} = 600$ V, $I_D = 80$ A	-	203	-	nC
Threshold Gate Charge	Q _{G(th)}		-	33	-	-
Gate-to-Source Charge	Q _{GS}		-	66	-	
Gate-to-Drain Charge	Q _{GD}		-	47	-	
Gate Resistance	R _G	f = 1 MHz	-	1.81	-	Ω
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	t _{d(on)}	$V_{GS} = -5/20 \text{ V}, V_{DS} = 800 \text{ V},$ $I_D = 80 \text{ A}, \text{ R}_G = 2 \Omega,$ Inductive Load	-	25	-	ns
Rise Time	t _r		-	57	-	
Turn-Off Delay Time	t _{d(off)}		-	45	-	1
Fall Time	t _f		-	11	_	
Turn-On Switching Loss	E _{ON}		-	2718	_	μJ
Turn-Off Switching Loss	E _{OFF}		-	326	-	
Total Switching Loss	E _{TOT}		-	3040	-	
DRAIN-SOURCE DIODE CHARACTER	RISTICS					
Continuous Drain-to-Source Diode Forward Current	I _{SD}	V_{GS} = -5 V, T _J = 25°C	-	-	54	A
Pulsed Drain-to-Source Diode For- ward Current (Note 2)	I _{SDM}	V_{GS} = -5 V, T _J = 25°C	-	_	412	A
Forward Diode Voltage	V _{SD}	V_{GS} = –5 V, I_{SD} = 30 A, T_J = 25 $^\circ C$	-	3.7	-	V
Reverse Recovery Time	t _{RR}	$V_{GS} = -5/20 \text{ V}, I_{SD} = 80 \text{ A},$	-	31	-	ns
Reverse Recovery Charge	Q _{RR}	dI _S /dt = 1000 A/µs	-	240	-	nC
Reverse Recovery Energy	E _{REC}	1	-	10	-	μJ
Peak Reverse Recovery Current	I _{RRM}	1	_	15	_	А

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

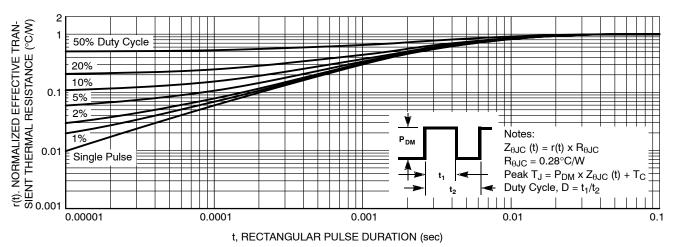


Figure 13. Junction-to-Ambient Thermal Response

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Packing Method	Reel Size	Tape Width	Quantity
NTHL020N120SC1	NTHL020N120SC1	TO-247 Long Lead	Tube	N/A	N/A	30 Units



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